

## Standard Recovery Diodes, (Hockey PUK Version), 700 A



B-PUK (DO-200AB)

### FEATURES

- Wide current range
- High voltage ratings
- High surge current capabilities
- Diffused junction
- Hockey PUK version
- Case style B-PUK (DO-200AB)
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT

### TYPICAL APPLICATIONS

- Converters
- Power supplies
- High power drives
- Auxiliary system supplies for traction applications

### PRIMARY CHARACTERISTICS

$I_{F(AV)}$	700 A
Package	B-PUK (DO-200AB)
Circuit configuration	Single

### MAJOR RATINGS AND CHARACTERISTICS

PARAMETER	TEST CONDITIONS	VALUES	UNITS
$I_{F(AV)}$		700	A
	$T_{hs}$	55	°C
$I_{F(RMS)}$		1310	A
	$T_{hs}$	25	°C
$I_{FSM}$	50 Hz	7500	A
	60 Hz	7850	
$I^2t$	50 Hz	281	kA <sup>2</sup> s
	60 Hz	257	
$V_{RRM}$	Range	3000	V
$T_J$		-40 to +150	°C

### ELECTRICAL SPECIFICATIONS

#### VOLTAGE RATINGS

TYPE NUMBER	VOLTAGE CODE	$V_{RRM}$ , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V	$V_{RSM}$ , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	$I_{RRM}$ MAXIMUM AT $T_J = T_J$ MAXIMUM mA
VS-SD700C..L	30	3000	3100	50

**FORWARD CONDUCTION**

PARAMETER	SYMBOL	TEST CONDITIONS			VALUES	UNITS	
Maximum average forward current at heatsink temperature	I <sub>F(AV)</sub>	180° conduction, half sine wave Double side (single side) cooled			700 (345)	A	
					55 (85)	°C	
Maximum RMS forward current	I <sub>F(RMS)</sub>	25 °C heatsink temperature double side cooled			1310		
Maximum peak, one-cycle forward, non-repetitive surge current	I <sub>FSM</sub>	t = 10 ms	No voltage reapplied	Sinusoidal half wave, initial T <sub>J</sub> = T <sub>J</sub> maximum	7500	A	
		t = 8.3 ms			7850		
		t = 10 ms	100 % V <sub>RRM</sub> reapplied		6310		
		t = 8.3 ms			6600		
Maximum I <sup>2</sup> t for fusing	I <sup>2</sup> t	t = 10 ms	No voltage reapplied			281	kA <sup>2</sup> s
		t = 8.3 ms				257	
		t = 10 ms	100 % V <sub>RRM</sub> reapplied			199	
		t = 8.3 ms				182	
Maximum I <sup>2</sup> √t for fusing	I <sup>2</sup> √t	t = 0.1 to 10 ms, no voltage reapplied			2810	kA <sup>2</sup> √s	
Low level value of threshold voltage	V <sub>F(TO)1</sub>	(16.7 % × π × I <sub>F(AV)</sub> < I < π × I <sub>F(AV)</sub> ), T <sub>J</sub> = T <sub>J</sub> maximum			0.88	V	
High level value of threshold voltage	V <sub>F(TO)2</sub>	(I > π × I <sub>F(AV)</sub> ), T <sub>J</sub> = T <sub>J</sub> maximum			0.99		
Low level value of forward slope resistance	r <sub>f1</sub>	(16.7 % × π × I <sub>F(AV)</sub> < I < π × I <sub>F(AV)</sub> ), T <sub>J</sub> = T <sub>J</sub> maximum			0.78	mΩ	
High level value of forward slope resistance	r <sub>f2</sub>	(I > π × I <sub>F(AV)</sub> ), T <sub>J</sub> = T <sub>J</sub> maximum			0.73		
Maximum forward voltage drop	V <sub>FM</sub>	I <sub>pk</sub> = 1000 A, T <sub>J</sub> = T <sub>J</sub> maximum, t <sub>o</sub> = 10 ms sinusoidal wave			1.66	V	

**THERMAL AND MECHANICAL SPECIFICATIONS**

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction operating temperature range	$T_J$		-40 to +150	°C
Maximum storage temperature range	$T_{Stg}$		-55 to +200	
Maximum thermal resistance, junction to heatsink	$R_{thJ-hs}$	DC operation single side cooled	0.11	K/W
		DC operation double side cooled	0.05	
Mounting force, ± 10 %			9800 (1000)	N (kg)
Approximate weight			250	g
Case style		See dimensions - link at the end of datasheet	B-PUK (DO-200AB)	

 **$\Delta R_{thJ-hs}$  CONDUCTION**

CONDUCTION ANGLE	SINUSOIDAL CONDUCTION		RECTANGULAR CONDUCTION		TEST CONDITIONS	UNITS
	SINGLE SIDE	DOUBLE SIDE	SINGLE SIDE	DOUBLE SIDE		
180°	0.011	0.011	0.008	0.008	$T_J = T_J$ maximum	K/W
120°	0.014	0.015	0.014	0.014		
90°	0.018	0.018	0.019	0.019		
60°	0.026	0.026	0.027	0.028		
30°	0.045	0.046	0.046	0.046		

**Note**

- The table above shows the increment of thermal resistance  $R_{thJ-hs}$  when devices operate at different conduction angles than DC

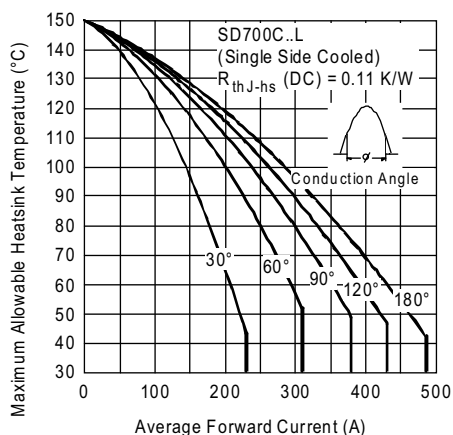


Fig. 1 - Current Ratings Characteristics

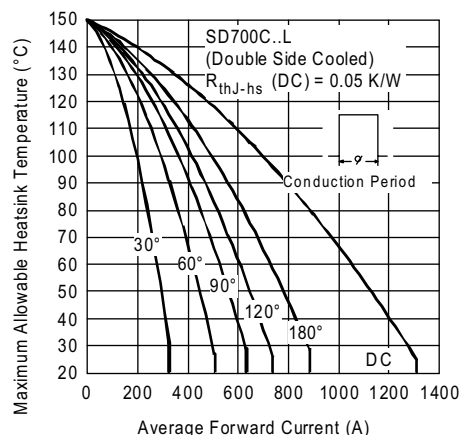


Fig. 4 - Current Ratings Characteristics

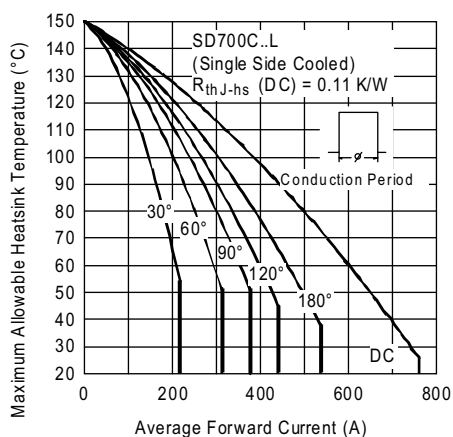


Fig. 2 - Current Ratings Characteristics

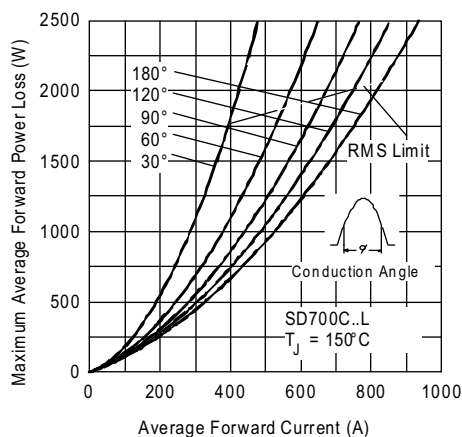


Fig. 5 - Forward Power Loss Characteristics

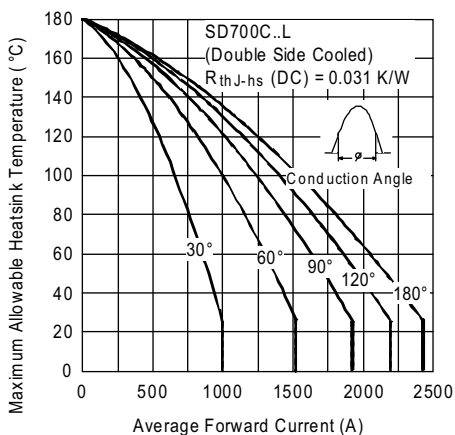


Fig. 3 - Current Ratings Characteristics

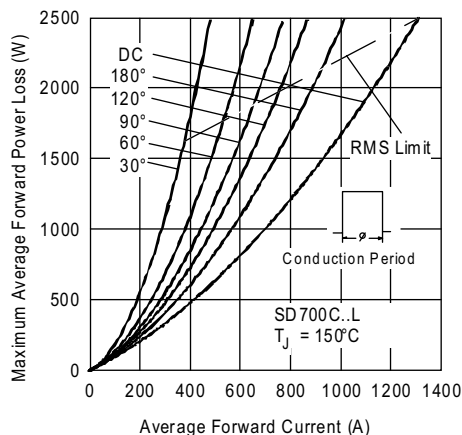


Fig. 6 - Forward Power Loss Characteristics

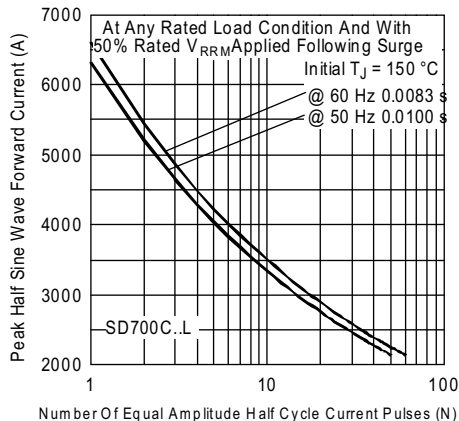


Fig. 7 - Maximum Non-Repetitive Surge Current  
Single and Double Side Cooled

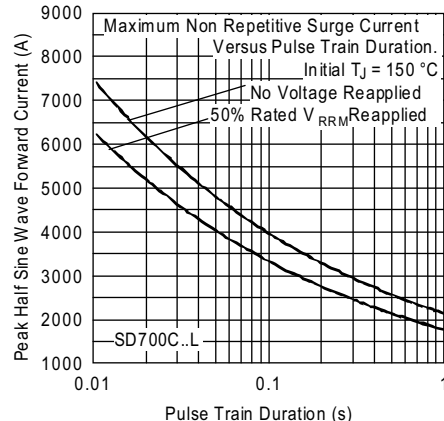


Fig. 8 - Maximum Non-Repetitive Surge Current  
Single and Double Side Cooled

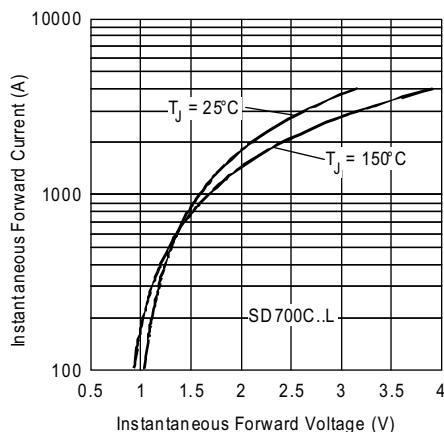


Fig. 9 - Forward Voltage Drop Characteristics

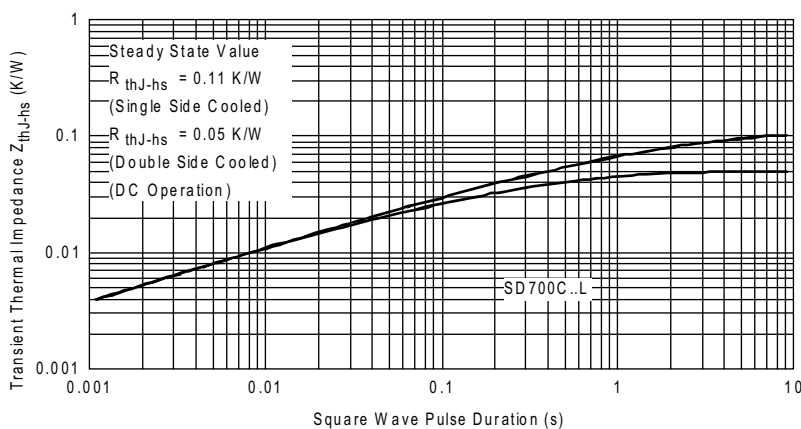


Fig. 10 - Thermal Impedance  $Z_{thJ-hs}$  Characteristics



ORDERING INFORMATION TABLE

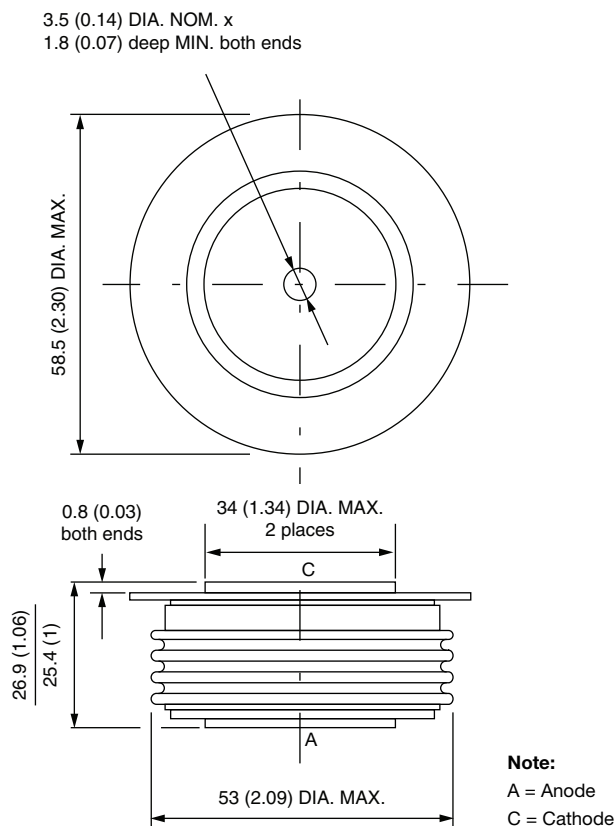
Device code	VS-	SD	70	0	C	30	L
	1	2	3	4	5	6	7
1	- Vishay Semiconductors product						
2	- Diode						
3	- Essential part number						
4	- 0 = standard recovery						
5	- C = ceramic PUK						
6	- Voltage code x 100 = $V_{RRM}$ (see Voltage Ratings table)						
7	- L = PUK case B-PUK (DO-200AB)						

LINKS TO RELATED DOCUMENTS	
Dimensions	<a href="http://www.vishay.com/doc?95246">www.vishay.com/doc?95246</a>



## B-PUK (DO-200AB)

**DIMENSIONS** in millimeters (inches)



Quote between upper and lower pole pieces has to be considered after application of mounting force (see Thermal and Mechanical Specifications)



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